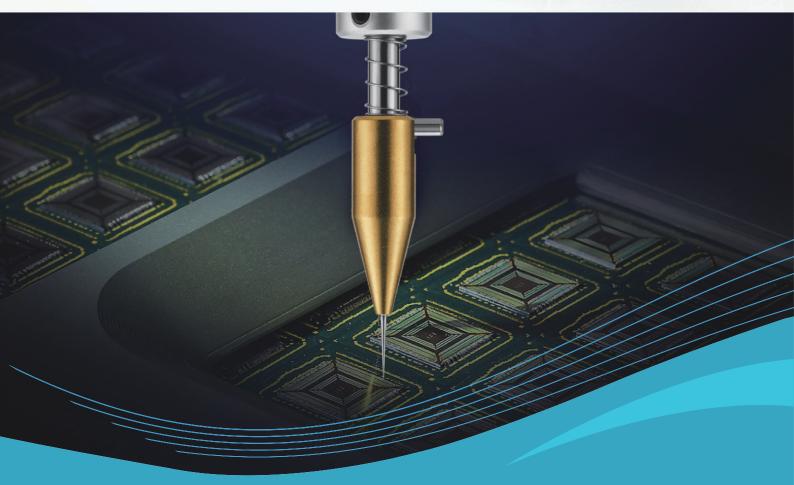


STANDARD: JEITA EIAJ ET-7407 JEDEC JESD22-B117A JEDEC JESD22-B115 JEDEC JESD22-B116 ASTM F1269 DT/NDT MIL STD 883 MIL STD 883E



MFM Series Multifunction Bond Tester



Application



Bond Tester is widely used in semiconductor packaging, optical communication device packaging, LED packaging, COB/COG process testing, research in mechanics of material in Military Institutions, material reliability testing and other applications. It is also a crucial dynamic mechanics testing device for SMT process, semiconductor manufacturing process and bonding process. MFM Tester is able to meet the demand for applications including: Gold wire / copper wire / alloy wire / aluminum wire / aluminum tape pull tests, gold ball / copper ball / tin ball / wafer / chip / SMD Shear tests, tin ball/Bump pin pull tests and so on. It has the advantages of high expandability, convenience, efficiency and accuracy.

Testing modules with different functions that can satisfy clients with needs of high testing variety

All modules base on digital close-loop DGFT® TECH







WP100G testing Module



DS100KG testing Module



BS5KG testing Module



The machine provides an independent automatic precision calibration function, which can simultaneously detect sensor precision and linear precision. The data of calibration is automatically saved in the testing module, while the data of calibrated precision and linear precision are automatically saved in the computer for user's inspection. The calibration adopts specialized weights, which can be checked by third parties. Calibration equipment and weights can be used for GR&R verification.



Device Tools (Hook/Shear tool/Tweezers etc.) With high quality/durability/accuracy and series of products ,Processed with specialized materials. These tools can be customized according to application requirements of users.







Precisely made work holder that are speciallized for testing and manufaturing

According to customer application requirements, tailor-made institutions, exquisite, manufacturing precision testing workholder. effectively guarantee the valuable testing

Highlights

1 Vertical Positioning Technology Patented

Try-Precision ensures all Shear modules (Ball/Die... Shear)position precisely without any deviation. These modules are incorporated with fast shear height setting and accurate to micron scale. Testing motion is smooth, accurate and coherent. The module has the advantages of light touch force, zero horizontal shift positioning, fast positioning action and accurate shearing height .etc.

Vertical Point Movement Technology Patented

For the first time in the industry of bond tester, TRY-Precision successfully achieved the objective that no deviation & displacement of the main shaft during pull testing, which ensures that all pull modules (Wire/Tweezer/Cold Bump/Cold Ball/Push/Pull) eliminate the unwanted effect to the test results caused by the component force due to the deviation of the main shaft.

Base on DGFT° TECH DGFT°(Digital Force technology)

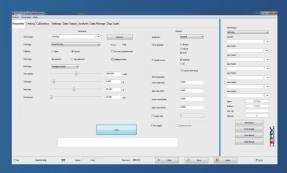
The DGFT® technology developed by TRY-Precision enables the function of exchanging modules between different bondtesters without loss of precision for the first in the industry. Such technology provides clients reliable technical supports for quick function switching, function expanding and resources sharing.

4 24Bit High resolution

The industry leading 24Bit ultra high resolution The resolution in full scale range exceeds the resolution in the smallest range of other companies. There is no need to worry about lossing range for increasing resolution.

5 Auto Range technology

The leading "automatic" technology is supported by unique algorithms. There is no need to set up testing ranges, which simplifies the operation process for User.





- Special, Powerful software which is easy to control
- Build in SPC function
- Multiple data output format
- Data processing & failure statistics
- Perfectly matches factory net work



Test Module

Shear Test- Ball/Die/Zone					
Transducer	Auto Range				
BS250G	250g	100g	50g	25g	
BS1KG	1000g	500g	200g	100g	
BS5KG	5kg	2.5kg	1kg	500g	
BS20KG	20kg	10kg	4kg	2kg	
DS100KG	100kg	50kg	20kg	10kg	
DS200KG	200kg	100kg	40kg	20kg	
ZoneDS-100KG	100kg	50kg	20kg	10kg	

Pull Test-Wire				
Transducer	Auto Range			
WP25G	25g	10g	5g	2.5g
WP50G	50g	25g	10g	5g
WP100G	100g	50g	25g	10g
WP1000G	1000g	500g	250g	100g
WP5KG	5kg	2.5kg	1.25kg	500g
WP10KG	10kg	5kg	2.5kg	1kg
WP20KG	20kg	10kg	5kg	2.5kg

Push Test- Down/Pull				
Transducer	Auto Range			
DP100G	100g	50g	25g	10g
DP5KG	5kg	2.5kg	1.25kg	500g
PP5KG	5kg	2.5kg	1.25kg	500g
PP50KG	50kg	25kg	10kg	5kg
Accuracy	MFM1200 Series		± 0.25% FS	3

Pull Test-Tweezer / ColdBump				
Transducer	Auto Range			
TP100G	100g	50g	25g	10g
TP5KG	5kg	2.5kg	1.25kg	500g
CBP100G	100g	50g	25g	10g
CBP5KG	5kg	2.5kg	1.25kg	500g
MFM1500 Series ±0.1% FS				

Specifications

	Machine footprint	Depth 600mm, Width 700mm (Including left and right joystick controllers), Height 800mm		
Machine	Weight	65kg		
	Power Supply	100/110V & 220 / 240V AC @ 4.0A 50/60Hz		
	Pneumatic	Supply (for machine) 4.5Bar Minimum		
	Vacuum	Supply (for workholder) 550mm Hg Minimum		
	Pneumatic	6mm OD/4mm ID plastic pipe		
	Control PC	Specialized PC with standard configuration		
	Operating System	Windows 7 / Windows 10		
	Microscope	Standard Motic (optional: LEICA / Nikon /OLYMPUS)		
	Max Force for Machine Body	500kg		
	X,Y axis travel	100*100mm(standard)		
	X,Y axis accuracy	±10 um Full Travel		
	X,Y axis repeatability	±5 um Full Travel		
	X,Y axis resolution	<0.125um		
	X,Y axis maximum speed	2 mm/s		
	Y axis maximum force	100kg(standard) 200kg(optional)		
Axis	X axis maximum force	20kg		
	Z axis travel	60mm		
	Z axis accuracy over Full Travel	± 10 um		
	Z axis accuracy over 2mm	± 1 um		
	Z axis resolution	± 0.125um		
	Z axis maximum speed	7 mm/s		
	Z axis maximum force	20kg		
XY Tables	100*100mm(standard)	Maximum Force:100kg(standard) 200kg(option)		
	200*200mm	Maximum Force:100kg(standard) 200kg(option)		
	320*320mm	Maximum Force:50kg(standard)		



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